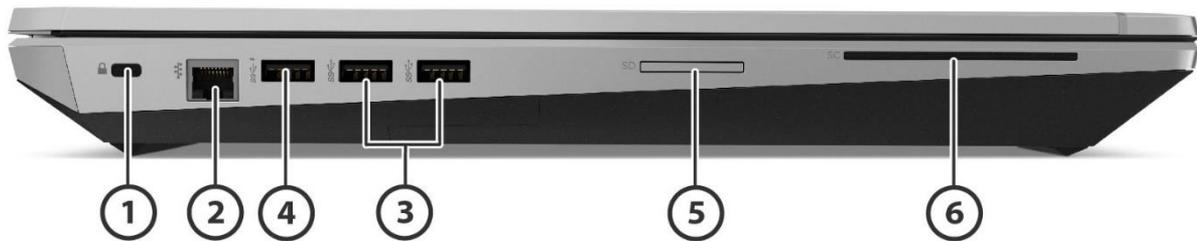


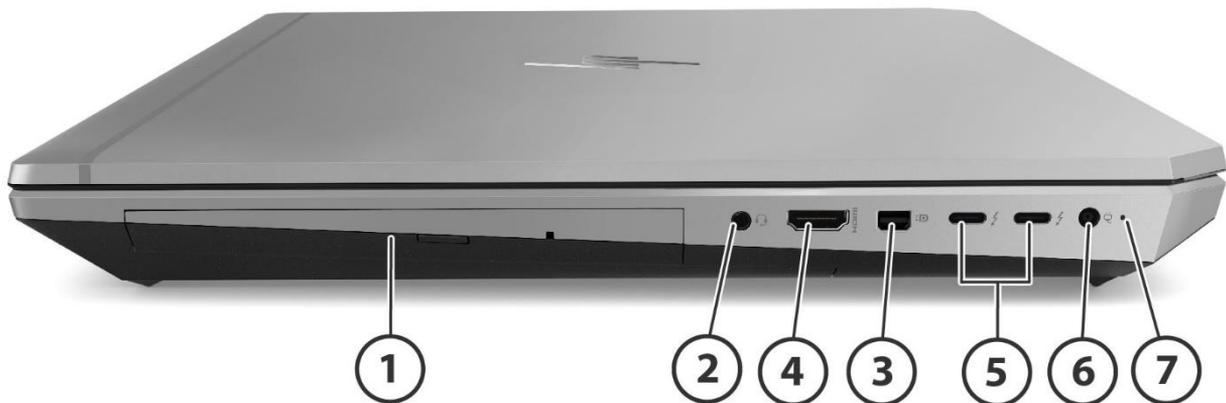
Overview

HP ZBook 17 G5 Mobile Workstation



Left View

- | | |
|------------------------|--------------------------|
| 1. Security cable slot | 4. USB 3.0 charging port |
| 2. RJ-45/Ethernet | 5. SD Card reader |
| 3. 2 USB 3.0 | 6. Smart Card Reader |



Right View

- | | |
|--|-------------------------|
| 1. Optical Disk Drive | 5. Thunderbolt™ 3 ports |
| 2. Stereo microphone in / headphone-out combo jack | 6. Power connector |
| 3. Mini DisplayPort™ | 7. Power LED |
| 4. HDMI 2.0 port | |

Overview



Bottom View

- 1. Fan Venting
- 2. Tool less access
- 3. Keyboard liquid drain

Overview

At A Glance

- Full performance stylish industrial design, aluminum and magnesium-reinforced chassis with HP's Turbo Silver color provides optimal durability with minimal weight.
- Featuring HP Collaboration Keyboard with Clickpad to manage most commonly used conferencing functions with a single keystroke. HP Spill Resistant Keyboard with Durakeys to help protect keys from fading.
- ISV certified to provide fast and reliable performance with workstation applications, including manipulation of 3D textures
- HP Performance Advisor for optimal configuration, compatibility and performance
- Designed to pass MIL-STD-810G testing*.
- Optional Workstation-caliber graphics:
 - NVIDIA® Quadro® discrete graphics featuring NVIDIA® Optimus technology:
 - NVIDIA® Quadro® P1000 (4GB GDDR5)
 - NVIDIA® Quadro® P2000 (4GB GDDR5)
 - NVIDIA® Quadro® P3200 (6GB GDDR5)
 - NVIDIA® Quadro® P4200 (8GB GDDR5)
 - NVIDIA® Quadro® P5200 (16GB GDDR5)
 - AMD RadeonPro™ WX 4170 (4GB GDDR5) featuring AMD Enduro™ technology
- Intel® Integrated graphics: Intel® UHD Graphics 630 integrated on Core™ i7. Intel® UHD Graphics P630 integrated on Xeon® processors.
- Choice of 8th generation Intel® Core™ i5 quad-core and Intel® Core™ i7 hexa-core or Intel® Xeon® hexa-core processors with option Intel® vPro™ technology.
- Populate up to four SODIMM slots supporting up to 64 GB DDR4-2667MHz dual channel memory. Up to 64GB ECC DDR4-2667MHz dual channel memory available with Intel® Xeon® processors.
- Supports multi-display, including up to four (4) displays without a docking solution, with hybrid graphics enabled. Supports up to six (6) displays or (2) 4K displays with HP Thunderbolt™ Dock G2 (sold separately), with hybrid graphics enabled.
- Choice of 17.3-inch diagonal LED-backlit displays:
 - HD+ IPS eDP anti-glare, 220 nits (1600x900)
 - FHD IPS eDP anti-glare 300 nits with ambient light sensor (1920x1080)
 - UHD IPS eDP + PSR Touch-screen 400 nits ambient light sensor (3840x2160)
 - HP DreamColor Technology, UHD IPS eDP + PSR , anti-glare 400 nits, 100% AdobeRGB with 10-bit color (3840x2160)
- Two (2) Thunderbolt™ 3 ports (supporting DP 1.3, USB 3.1, PCIe Gen 3 devices) on the new USB-C™ connector, for high speed data/video/audio transfer support.
- Flexible wireless connectivity options:
 - Intel® Dual Band Wireless-AC 9560 802.11 AC/a/b/g/n (2x2) WiFi and Bluetooth 5.0 combo adaptor (non-vPro™) or, Intel® Dual Band Wireless-AC 9560 802.11 AC/a/b/g/n (2x2) WiFi and Bluetooth 5.0 combo adaptor (vPro™)
 - Optional integrated wireless 4G (LTE) mobile broadband module support
- Optimize your audio experience for conference calls and remote collaboration with optional HD webcam, dual-array microphones, premium speakers, HP Noise Cancellation Software, HP Audio Boost, and audio. Custom-tuned by HP and Bang & Olufsen optimized for high fidelity audio with immersive surround sound with deep, rich bass and crystal-clear dialog without distortion at high volume, and new discrete amp.
- HP Long life battery solution: 6-cell (96 WHr) supporting HP Fast Charge capability
- Four (4) dedicated drive slots, three (3) M.2 slots, and one (1) 2.5" drive bays; Optical disk drive bay with option for extra M.2 Storage module supporting up to 10TB of data. Enterprise grade security features including HP Client Security Manager, HP SureClick, HP WorkWise, HP SureView, and HP SureStart self-healing BIOS. Low halogen HP BIOS technology, including HP Sure Start to identify and recover from unknown BIOS attacks, TPM 2.0, Touch Fingerprint Sensor, Integrated Smart Card Reader, BIOS Preboot power on, and Drive Encryption preboot option

*MIL STD 810G testing is pending and is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

Overview

NOTE: See important legal disclosures for all listed specs in their respective features sections.

Features

OPERATING SYSTEM

Preinstalled	Windows® 10 Pro 64 ¹ Windows 10 Pro for Workstations 64 Windows® 10 Home 64 ¹ FreeDOS 2.0
Supported	Windows® 10 Enterprise 64 ¹ Red Hat® Enterprise Linux® (REHL) 7 Ubuntu Linux 16.04

¹Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>

PROCESSOR^{*,**,***}

8th Generation Intel® Core™ i5+ 8300H (Core i5 and 16GB Intel® Optane™ memory) with Intel® UHD Graphics 630 (2.3 GHz (up to 4.0 GHz)/2667 MHz/ 8 MB L3 cache/45W)

8th Generation Intel® Core™ i5-8300H with Intel® UHD Graphics 630 (2.3 GHz (up to 4.0 GHz)/2667 MHz/ 8 MB L3 cache/45W)

8th Generation Intel® Core™ i5+ 8400H vPro™ processor (Core i5 and 16GB Intel® Optane™ memory) with Intel® UHD Graphics 630 (2.5 GHz (up to 4.2 GHz)/2667 MHz/ 8 MB L3 cache/45W)

8th Generation Intel® Core™ i5-8400H vPro™ processor with Intel® UHD Graphics 630 (2.5 GHz (up to 4.2 GHz)/2667 MHz/ 8 MB L3 cache/45W)

8th Generation Intel® Core™ i7+ 8750H (Core i7 and 16GB Intel® Optane™ memory) with Intel® UHD Graphics 630 (2.2 GHz (up to 4.1 GHz)/2667 MHz/ 9 MB L3 cache/45W)

8th Generation Intel® Core™ i7-8750H with Intel® UHD Graphics 630 (2.2 GHz (up to 4.1 GHz)/2667 MHz/ 9 MB L3 cache/45W)

8th Generation Intel® Core™ i7+ 8850H vPro™ processor (Core i7 and 16GB Intel® Optane™ memory) with Intel® UHD Graphics 630 (2.6 GHz (up to 4.3 GHz)/2667 MHz/ 9 MB L3 cache/45W)

8th Generation Intel® Core™ i7-8850H vPro™ processor with Intel® UHD Graphics 630 (2.6 GHz (up to 4.3 GHz)/2667 MHz/ 9 MB L3 cache/45W)

Intel® Xeon® E-2176M vPro™ processor with Intel® UHD Graphics P630 (2.7 GHz (up to 4.4 GHz)/2667 MHz/12 MB L3 cache/45W)

Intel® Xeon® E-2186M vPro™ processor with Intel® UHD Graphics P630 (2.9 GHz (up to 4.6 GHz)/2667 MHz/12 MB L3 cache/45W)

*Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

**Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system.

***Intel Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.

Note: In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD 7th generation and forward processors or provide any Windows®8 or Windows 7 drivers on <http://www.support.hp.com>

Features

CHIPSET

Mobile Intel® CM246

INTEL® CORE™ I5 WITH VPRO™/CORE I7 WITH VPRO™/XEON® WITH VPRO™ TECHNOLOGY CAPABLE

Intel® Core™ i5 with vPro™, Core™ i7 with vPro™ and XEON® with vPro™ technology is a selectable feature that is available on units configured with select processors, a qualified Intel® Centrino® WLAN module and a preinstalled Windows® operating system. It provides advances in remote manageability, security, energy efficient performance, and wireless connectivity. Intel® Active Management Technology (iAMT) offers built-in manageability and proactive security for networked mobile workstations, even when they are powered off* or when the operating system is inoperable. It can help identify threats before they reach the network, isolate infected systems, and update regardless of their power state.

* Requires a Windows operating system, network hardware and software, connection with a power source, and a direct (non-VPN) corporate network connection which is either cable or wireless LAN.

NOTE: Some functionality of Intel® Core™ i5 with vPro™/Core™ i7 with vPro™/Xeon® with vPro™ technology, such as Intel® Active Management technology and Intel® Virtualization technology, requires additional third- party software in order to run. Availability of future "virtual appliances" applications for Intel® Core™ i5 with vPro™/Core i7 with vPro™/XEON® with vPro™ technology is dependent on third- party software providers. Compatibility with future "virtual appliances" is yet to be determined.

Features

GRAPHICS

Intel® Integrated

Intel® UHD graphics 630^{1,2};
Intel® UHD graphics P630^{1,2};

Discrete³

AMD RadeonPro™ WX 4170 with 4 GB dedicated GDDR5 video memory
Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

NVIDIA® Quadro® P1000 with 4 GB dedicated GDDR5 video memory
Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

NVIDIA® Quadro® P2000 with 4 GB dedicated GDDR5 video memory
Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

NVIDIA® Quadro® P3200 with 6 GB dedicated GDDR5 video memory
Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

NVIDIA® Quadro® P4200 with Max-Q Design 8 GB dedicated GDDR5 video memory
Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

NVIDIA® Quadro® P5200 with Max-Q Design 16 GB dedicated GDDR5 video memory
Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

NOTE 1: UHD content required to view UHD images.

NOTE 2: Intel® HD graphics 630 is configurable as a standalone graphics option; Intel® HD graphics P630 only used when NVIDIA® Optimus™ Technology is enabled.

NOTE 3: NVIDIA® Quadro® mobile professional graphics support up to four independent displays when using a HP ZBook Dock with Thunderbolt™ 3 (sold separately) or DP 1.2 hubs with MST. AMD RadeonPro™ professional graphics support up to six independent displays when using an HP ZBook Dock with Thunderbolt™ 3 (sold separately) or DP 1.2 hubs with MST.

NOTE: Intel® HD Graphics 630 integrated on Core™ i7 and Core™ i5 processors. Intel® HD Graphics P630 integrated on Xeon® processors.

DisplayPort™ 1.3 protocol features supported on Thunderbolt™ 3 ports:

- Legacy displays (HDMI, DVI, VGA) may be attached to Thunderbolt™ port with the use of a certified dongle.
- DisplayPort™ monitors capable of supporting DisplayPort™ 1.3 may be directly attached to the Thunderbolt™ port to achieve HBR2 with the use a dongle.
- DisplayPort™ monitors capable of supporting DP 1.3 may be directly attached to the Thunderbolt™ port to achieve HBR2 with the use a dongle.
- Thunderbolt™ 3 enabled monitors may be directly attached to the Thunderbolt™ port to achieve HBR2 and MST.
- DisplayPort™ 1.3 MST feature ("daisy-chain" feature) is supported through Thunderbolt™ 3 port on Thunderbolt™ 3 enabled devices or DisplayPort™ 1.3 monitors (requires monitor with DisplayPort™ 1.3 MST capability) with the use of a dongle.
- Up to 2 streams (eight lanes) of DisplayPort™ 1.3 are supported over a single Thunderbolt™ 3 port. Up to (2) 4K displays 24/30-bit color depth at 60 Hz or (1) 5K display supported over a single Thunderbolt™ 3 port. (Requires Intel® certified Thunderbolt™ cable).
- DisplayPort™ 1.3 w/MST (Multi-stream Transport): Supports resolutions up to Full 4K, 24/30-bit color depth at 60 Hz, and WUXGA (1920 x1200) monitors, 24/30-bit color depth at 120 Hz.

Features

*Thunderbolt™ 3 is superset port supporting DisplayPort™ 1.3, USB 3.1 Gen 2, and PCIe Gen 3 devices over the new USB-C™ connector. Install all the latest drivers for your Thunderbolt™ device before connecting the device to the Thunderbolt™ port.

Multi-Display Support

Without HP Thunderbolt Dock G2:

HP ZBook 17 with hybrid graphics and without the use of the ZBook dock supports up to a maximum of four independent displays. These four displays are the internal panel plus three external displays connected to the Mini DisplayPort™ 1.3 and two of the three following ports: HDMI 2.0, Thunderbolt™ 3, Thunderbolt™ 3. HP ZBook 17 configuration with Intel® integrated graphics and without the use of the ZBook dock supports up to a maximum of three independent displays. Any three-display combination of the system panel: HDMI, Thunderbolt™ 3, Thunderbolt™ 3.

With HP Thunderbolt Dock G2:

The HP Thunderbolt Dock G2 has Thunderbolt™ 3 port, VGA, two DisplayPort™ 1.3, and a USB-C port. When used together with the HP ZBook 17 configuration with hybrid graphics, a maximum of 6 independent displays are supported. These six displays are internal panel, one external display connected to the system's HDMI port and four external displays connected to the ZBook dock's Thunderbolt™ 3, VGA, and two DisplayPort™ ports. When used together with the HP ZBook 17 configuration with Intel® integrated graphics, a maximum of 3 independent displays are supported. Any three display combination of the system panel, system ports and ZBook Dock ports.

Features

DISPLAY

Internal

- 17.3" diagonal HD+ IPS eDP anti-glare LED-backlit, 220 nits (1600x900)
- 17.3" diagonal FHD IPS eDP anti-glare LED-backlit, 300 nits with ambient light sensor (1920x1080)
- 17.3" diagonal UHD IPS eDP + PSR Touch screen with Corning® Gorilla® Glass 4, LED-backlit, 400 nits ambient light sensor (3840x2160)
- HP Dream Color Display, 17.3" diagonal UHD IPS eDP + PSR, anti-glare, RG phosphors - LED-backlit, 400 nits, 100% AdobeRGB with 10-bit color (3840x2160)

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

STORAGE AND DRIVES

1) Optical disk drive

Blu-ray R/RE DVD +/-RW SuperMulti DL Drive

(3) M.2

SATA SED Solid State Drives*

256 GB SATA Self Encrypting Drive (SED) Solid State Drive

512 GB SATA FIPS 140-2 Solid State Drive

16GB Intel® Optane Cache (Must be configured with Hard Disk Drive)

HP Z Turbo Drives (NVMe PCIe SSD)

256GB PCIe (NVMe) TLC Solid State Drive

360GB PCIe (NVMe) TLC Solid State Drive

512GB PCIe (NVMe) TLC Solid State Drive

1 TB PCIe (NVMe) TLC Solid State Drive

2 TB PCIe (NVMe) TLC Solid State Drive

256GB PCIe (NVMe) TLC SED Solid State Drive

512GB PCIe (NVMe) TLC SED Solid State Drive

(1) 2.5" Storage Bay Drives*

2 TB 5400 rpm SATA Hard Disk Drive

2 TB SATA SSHD (Hybrid Drive) (8 GB cache)

1 TB SATA SSHD (Hybrid Drive) (8 GB cache)

1 TB 7200 rpm SATA Hard Disk Drive

500 GB 7200 rpm SATA Hard Disk Drive

500 GB SATA SSHD (Hybrid Drive) (8 GB cache)

500 GB 7200 rpm SATA Self Encrypting Drive (SED) Hard Disk Drive

500 GB 5400 rpm SATA Self Encrypting Drive (SED) FIPS 140-2 Hard Disk Drive

256GB SATA Solid State Drive

1 TB SATA Solid State Drive

HP 3D DriveGuard (Windows only)

The hard drive is mounted directly to the notebook frame, reducing the transmission of shock to the hard drive. Uses three-axis digital motion detection with intelligent sensitivity to help protect the hard drive during normal use from shock and vibration. The digital accelerometer temporarily halts all data transfer and parks the hard drive when abrupt motion is detected.

Features

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

DRIVE CONTROLLERS

2.5" Storage Bays and M.2 Storage Bay (SATA):	SATA-3 or SATA-2 for HDD and SATA-3 for SSD
HP Z Turbo Drive:	PCIe NVMe SSD
RAID:	0, 1 supported*

NOTE: Raid 0, 1 supported only on SATA drives.

MEMORY

Standard

64 GB DDR4 ECC or Non-ECC SDRAM (With transfer rates up to 2667MT/s¹)
Four SODIMM slots supporting dual-channel memory; two SODIMMs slots are customer accessible or upgradeable
4 GB, 8GB and 16 GB SODIMMs (for Intel® Core™ Processors)
8GB and 16 GB ECC SODIMMs (for Intel® XEON® Processors)

Maximum

Upgradeable to 64 GB with optional 16 GB SODIMMs in all 4 slots

Dual-channel

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory channels.

NOTE 1: Only 2 DIMM configurations run at 2400 MHz . 4 DIMM configurations run at 2133 MHz.

NOTE: Maximum memory capacities assume Windows 64-bit operating systems. With Windows 32-bit operating systems, memory above 3 GB may not all be available due to system resource requirements.

NETWORKING/COMMUNICATIONS

Communications*

Intel® I219-LM Gigabit* Network Connection (vPro configurations)

Wireless

Support for a broad range of secure, integrated wireless LAN and wireless WAN options featuring support for the latest industry standards. Optional Broadband Wireless (WWAN) requires a Windows® operating system and is available in select countries as a standard, factory configurable feature only. Integrated Bluetooth® is also available (factory configurable only) and can be combined with any of the supported wireless LAN and wireless WAN options.

802.11 Wireless LAN options**

Intel® Dual Band Wireless-AC 9560 802.11ac (2x2) Wi-Fi® and Bluetooth® 5.0 Combo, vPro™
Intel® Dual Band Wireless-AC 9560 802.11ac (2x2) Wi-Fi® and Bluetooth® 5.0 Combo, non-vPro™

Wireless WAN - Mobile Broadband options***

Intel® XMM™ 7360 LTE-Advanced
HP It4132 LTE/HSPA+ 4G Mobile Broadband Module

Features

Near Field Communication¹

NFC Mirage WNC XRAV-1 (NXP NPC300 I2C 10mmx17mm)

*The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

**Wireless cards are optional or add-on features and requires separately purchased wireless access point and internet service. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

*** WWAN use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, and in all regions.

¹Sold separately or as an optional feature.

AUDIO/MULTIMEDIA

Audio¹

Audio custom-tuned by HP and Bang & Olufsen, dual stereo speakers

Dual array digital microphone

Optional World Facing microphone

Functions keys for volume up and down

Combo microphone/headphone jack

HD audio; featuring HP Noise Cancellation Software, HP Clear Sound Amp and Skype for Business Certification

Webcam^{*,**}

Optional HP Privacy Camera (720p HD webcam)

Optional HP Privacy Camera (720p HD webcam) IR camera for face authentication with Windows Hello

- Privacy Camera features sliding camera shutter (non-touch only)
- HD format (widescreen)
- Supports videoconferencing and still image capture
- High quality fixed focus lens
- Video capture at various resolutions up to 1280x720 resolution (720p) and up to 30fps
- M-JPEG compression supports higher frame rates for video capture and videoconferencing
- Improved low light sensitivity
- Improved dynamic range

* HD content required to view HD images.

**Optional or add-on feature.

Note 1: Dual-microphone array when equipped with optional webcam and optional world facing microphone

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

Full-size, spill-resistant backlit HP Premium Collaboration Keyboard to manage most commonly used conferencing functions with a single keystroke with Durakeys to help protect keys from fading, featuring function key control and numeric keypad

Pointing Devices

Features

Clickpad with Image sensor touchpad with on/off button, two-way scroll, gestures, three buttons; Pointstick with three additional pointstick buttons

Buttons and Function Keys

Discrete buttons provide easy access to the following features:

F1 – Display Switching

F2 – HP Sure View (if configured)

F3 - Brightness Down

F4 – Brightness Up

F5 – Speaker mute

F6 – Volume down

F7 – Volume up

F8 – Microphone mute

F9 – Keyboard backlight

F10 – NumLock

F11 – Wireless on/off

F12 – Calendar

F13 – Share screen

F14 – Call

F15 – End Call

Features

SOFTWARE AND SECURITY

Preinstalled Software with Windows® Operating System

BIOS

HP BIOSphere Gen4¹
HP Sure Start Gen4²
HP DriveLock | HP Automatic DriveLock
BIOS Update via Network
Master Boot Record Security
Power On Authentication
Secure Erase³
Absolute Persistence Module⁴
Pre-boot Authentication
Measured Boot
HP Sure Click
HP LAN-WLAN Protection

Multi Media

Cyberlink Power MediaPlayer CMIT

Communication / Connectivity

HP Mobile Connect Pro⁵
Native Miracast Support⁶
HP MAC Address Manager (select models only)
HP Host Based Mac Address
HP Wireless Wakeup (select models only)
HP SureConnect

HP Value Add Software

HP 3D DriveGuard 6
HP ePrint Driver + JetAdvantage⁷
HP Hotkey Support
HP Recovery Manager
HP Jumpstart
HP Support Assistant¹²
HP Noise Cancellation Software
HP Performance Advisor
HP Remote Graphics Software
HP Velocity

Microsoft Products

Buy Office
Bing Search
Skype⁸

Manageability

HP Driver Packs⁹
HP SoftPaq Download Manager (SDM)
HP System Software Manager (SSM)⁹
HP BIOS Config Utility (BCU)⁹
HP Client Catalog⁹
HP Manageability Integration Kit for Microsoft SCCM¹⁰
HP Image Assistant
LANDESK Management¹¹

For more information on HP Client Management Solutions refer to: <http://www.hp.com/go/clientmanagement>.

Features

Client Security Software

- HP Client Security Suite Gen3¹³
- HP Security Manager (including Credential Manager and Password Manager¹⁶)
- HP Fingerprint Sensor
- IR Camera with Windows Hello
- Power On Authentication
- Device Access Manager
- Microsoft Defender¹⁴
- HP WorkWise¹⁵

Standard

For Windows 10, Trusted Platform Module (TPM) 2.0 (Infineon SLB9670). Common Criteria EAL4+ Certified. For more information on HP Client Security Software Suite, refer to <http://www.hp.com/go/clientsecurity>.

1. HP BIOSphere Gen4 requires Intel® or AMD 8th generation processors.
2. HP Sure Start Gen4 is available on HP Z Workstations products equipped with 8th generation Intel® or AMD processors.
3. HP Secure Disk Erase is for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.
4. BIOS Absolute Persistence module is shipped turned off, and will be activated when customers purchase and activate a subscription. Service may be limited. Check with Absolute for availability outside the U.S. The optional subscription service of Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: <http://www.absolute.com/company/legal/agreements/computrace-agreement>. If Data Delete is utilized, the Recovery Guarantee payment is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either create a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
5. HP Mobile Connect Pro is only available on preconfigured devices with WWAN. For geographic availability refer to <http://www.hp.com/go/mobileconnect>
6. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: <http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast>
7. Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see <http://www.hp.com/go/eprintcenter>). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.
8. Skype is not offered in China.
9. Not preinstalled, however available for download at <http://www.hp.com/go/clientmanagement>
10. HP Manageability Integration Kit can be downloaded from <http://www8.hp.com/us/en/ads/clientmanagement/overview.html>
11. Subscription required.
12. Requires Windows and Internet Access
13. Requires Windows and Intel® 7th generation processors.
14. Opt in and internet connection required for updates
15. HP WorkWise smartphone app is available as a free download on the App Store and Google Play
16. HP Password manager requires Windows.

Linux Hardware Matrix for HP Workstations

Features

RHEL 7 certifications pending. As of this edition of this matrix, some Enterprise-class Linux releases enable the Intel® architecture used in this system. HP considers enablement for the CPU, chipset, and the on-board LAN to be minimum requirements.

At this time, there are no other supported Linux distributions for this mobile workstation. When additional updates are ready, additional columns for supported releases will be added to this document.

Product Items/Features (Blank box indicates the listed component is NOT functional w/ as-is OS)	RHEL 7.3 or later (x86_64)	RHEL 7.3 or later (x86_64)
HP Workstation Base System		
Base system includes: Chassis, System Board, Power Supply, etc.	.	.
HP Localization Kit	1	1
All Supported Processors		
All supported 7th generation Intel® Core™ i7, i5 and Xeon® processors	.	.
System RAM		
Minimum (GB)	4GB	4GB
Maximum (GB)	64GB	64GB
Graphics Card (Video Card)		
Intel® HD integrated graphics 630 on Core™ i7 processors	5	5
Intel® HD integrated graphics P630 on Xeon® processors	5	5
AMD WX4170 with 4 GB of graphics memory		
NVIDIA® Quadro® M1200 with 4 GB of graphics memory	6	6, 11
NVIDIA® Quadro® M2200 with 4 GB of graphics memory	6	6, 11
NVIDIA® Quadro® P3000 with 6 GB of graphics memory	6	6, 11
NVIDIA® Quadro® P4000 with 8 GB of graphics memory	6	6, 11
NVIDIA® Quadro® P5000 with 16 GB of graphics memory	6	6, 11
Display - internal panel		
17.3" diagonal FHD IPS eDP anti-glare 300 nits with ambient light sensor (1920x1080)	.	.
17.3" diagonal HD+ IPS eDP anti-glare, 220 nits (1600x900)	.	.
HP DreamColor Technology, 17.3" diagonal UHD IPS eDP + PSR, anti-glare 400 nits, 100% AdobeRGB with 10-bit color (3840x2160)	.	.
17.3" diagonal UHD IPS eDP + PSR Touch screen 400 nits ambient light sensor (3840x2160)	7	7
Hard Disks		
All supported 2.5" AHCI SATA Hard Disk Drives	.	.
All Supported M.2 Solid State Drives	.	.
All Supported HP Z Turbo Drive NVMe PCIe-attached storage	.	.
All Supported M.2 SATA SED Solid State Drives	8	8
Onboard Components		
Wired LAN - Intel® i219LM Gigabit Ethernet	.	.
Onboard Audio (Conexant codec)	.	.
Onboard SATA RAID	2	2
Intel® dual-band wireless AC 9560 802.11 AC/a/b/g/n (2x2) WiFi + Bluetooth (vPro & non-vPro)	.	.
Mobile Broadband - HP It4132, LTE/HSPA+ 4G w/GPS		
Mobile Broadband - Intel® XMM™ 7360 LTE-Advanced		
HP HD (720p) webcam	.	.
Thunderbolt 3™ ports	3	3
USB 3.0 ports	.	.

Features

Input/Output Devices

Clickpad	.	.
TPM Module	4	4
Smart Card	.	.
HP Media Card Reader	.	.
External HDMI port	.	.
External VGA port	.	.

Dock Options

Zbook dock with Thunderbolt 3TM	9,11	10,11
HP USB Type-C Elite dock		

Note 1: Typical Linux distributions support many possible localizations. If you're installing the OS yourself, you can make selections for language and keyboard layout during that process. For a pre-loaded Linux OS, similar choices can be made during the "firstboot" process. In some cases, extra font packages may be available. HP Workstations can be ordered with a variety of localization options that may vary by platform.

Note 2: Hardware RAID is not supported on SATA drives. Software RAID is available in most Linux OSes and can be used with SATA or PCIe storage devices.

Note 3: Newer Linux kernels may provide device functionality through the Thunderbolt ports. Such kernels are likely to be available in leading-edge distributions, but inclusion of the support with any Enterprise Linux distribution is at the distributor's discretion.

Note 4: Support for the TPM or other security devices varies by OS distribution.

Note 5: The Intel® HD graphics works with the in-box frame-buffer drivers. Support for the "native" Intel® driver on v7 processors (Kaby lake) is not available for most release streams as of this edition of the table.

Note 6: HP recommends use of Nvidia driver 375.66 (or newer) on Nvidia graphics options.

Note 7: As of this edition of the table, only basic touch capability was available in most Linux desktop managers and no desktops are optimized for a satisfactory touch experience.

Note 8: SED drives work with Linux. There is, however, no Linux support available for manipulating encryption settings via the Opal API.

Note 9: The Thunderbolt dock is compatible with RHEL 7 on this zbook model, starting with RHEL 7.3.

Note 10: The Thunderbolt dock is compatible with Ubuntu 16.04, starting with 16.04.1. The one known limitation is that the audio headphone jack does not work.

Note 11: With Nvidia-based configurations, it is recommended to use the Nvidia closed source driver when using externally connected displays. It is not currently recommended to use the dock with AMD graphics options at this time.

Workstation ISV Certifications

See the latest list of certifications at: <http://www.hp.com/go/isv>

HP Remote Graphics Software

The remote desktop solution for serious workstation users and their most demanding applications.

Download at: <http://www.hp.com/go/RGS>

HP Performance Advisor

HP Performance Advisor enables optimal configuration of HP Mobile Workstations delivering stability and best performance. HP Performance Advisor will guide your system setup allowing a "custom" configuration that best matches the workstation to user requirements.

Download at: <http://www.hp.com/go/performanceadvisor>

Other Standard Security Features

BIOS Update via Network

Pre-boot Authentication

SATA 0,1 port disablement (viaBIOS)

RAID configurations

Serial, USB enable/disable (viaBIOS)

Power-on password (viaBIOS)

Features

Setup password (viaBIOS)
Support for chassis padlocks and cable lock devices
Measured Boot
HP Sure Click¹
Integrated Smart Card Reader
One-Step Logon
Security lock slot
Support for Intel® AT
TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)
HP Sure Run²
HP Sure Recovery³

TPM

Model: Infineon SLB9670
Version: 7.62.3126.0
Revision: TPM 2.0
FIPS 140-2 Compliant: Yes (select models only)

Optional Security Features

HP Fingerprint Sensor (optional)⁴
IR Camera with Windows Hello
Absolute Data Protect* with GPS Tracking - Subscription based security solution providing the ability to track, initiate physical recovery, conduct asset management, and perform remote data delete by utilizing GPS technology. GPS functionality requires HP Mobile Broadband Module.

* The Absolute Data Protect agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S.

1. HP Sure Click is available on select platforms only as a web-download from the HP Support website, is preinstalled on select HP platforms and supports Microsoft® Internet Explorer and Chromium™. Check <http://h20195.www2.hp.com/v2/GetDocument.aspx?docname=4AA7-0922ENW> for all compatible platforms as they become available.
2. HP Sure Run is available on HP Elite products equipped with Intel® or AMD® 8th generation processors
3. HP Sure Recover is available on HP Elite PCs with 8th generation Intel® or AMD processors and requires an open, wired network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data
4. Finger Sensor is optional

HP CENTRAL MANAGEMENT

HP offers a variety of scalable hardware, software, and BIOS-based security features to help you defend your organization against viruses and other threats. These integrated security features safeguard what matters to you the most - your data, device and identity. Now, be confident your fleet of devices is protected in multiple layers of HP Client Security protection.

HP BIOS Protection keeps you up and running with enhanced protection against virus attacks and other threats. And if the BIOS is accidentally compromised, the auto recovery feature automatically restores it to its fully functional state.

HP Sure Start detects and negates a BIOS attack with automatic recovery of the BIOS even when the installation is accidentally compromised (i.e. power outage). When HP Sure Start heals the BIOS an event log is generated that an IT administrator can retrieve so the business is aware of a BIOS attack. Golden copy of BIOS is stored in protected nonvolatile memory providing redundant, hardware-based protection against a new generation of attacks. This helps to future-proof your technology and business.

Features

An optional fingerprint reader and integrated Smart Card Reader help keep your identity secure. The security cable slot helps keep your notebook physically secure.

You can even permanently destroy data on your hard drive in preparation for your system disposal or redeployment with Secure Erase.

POWER

Power Supply

HP 200W Slim Smart AC adapter
(165 x 79 x 25.4 mm)

Primary Battery

HP Long Life 6-cell Prismatic Battery (96 WHr) *

NOTE: Battery is internal and not replaceable by the customer

Battery Life

Battery life up to TBD**

Battery life up to TBD**

System Standby Time

Up to TBD weeks***

* Available with 3-year limited warranty only

** Windows® 10 MM014 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See <http://www.bapco.com> for additional details.

*** Standby life will vary depending on various factors including battery, Memory, CPU, EC and LAN chip. The maximum capacity of the battery will naturally decrease with time and usage.

Power Conservation

NVIDIA® Optimus or AMD Enduro™ technology
Hibernation
Standby
ACPI compliance

ENVIRONMENTAL

US ENERGY STAR®
IT ECO declaration
EPEAT® Gold registered*
Low Halogen**

* EPEAT® Gold registered where applicable. EPEAT registration varies by country. See www.epeat.net for registration status by country. See HP's 3rd party option store for solar energy accessory www.hp.com/go/options.

**External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.

Features

WEIGHTS & DIMENSIONS

Weight

Starting at 7.0 lb. (3.2kg.)

Dimensions (w x d x h)

16.4 in x 11.35 in x 1.3 in

416 mm x 288 mm x 33.5 mm

NOTE: Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components. Weight includes Quad Core CPU, FHD, Intel® HD graphics, 8GBx1 SODIMM, HP Z Turbo Drive, wLAN/BT, FPR, 9-cell battery, no wWAN.

PORTS/SLOTS

Ports**Left side:**

- 1) RJ-45 (Ethernet)
- (1) USB 3.0 Charging Port
- (2) USB 3.0
- (1) Security lock slot

Right side:

- (1) Power connector;
- (2) Thunderbolt™ 3* (Supporting DisplayPort™ 1.3, USB 3.1 Gen2, PCIe Gen 3 devices)
- (1) Mini DisplayPort™ 1.3
- (1) HDMI 2.0
- (1) Stereo microphone in / headphone-out combo jack;

Thunderbolt™ 3

Thunderbolt™3 ports supports DisplayPort™ 1.3, USB 3.1 Gen 2, and PCIe Gen 3 devices over the new USB-C port connector. The port is compatible with existing DisplayPort™ displays, devices, and cables. Install all the latest drivers for your Thunderbolt™ device before connecting the device to the Thunderbolt™ port. Thunderbolt™ cable and Thunderbolt™ device (sold separately) must be compatible with Windows®. To determine whether your device is Thunderbolt™ Certified for Windows, see <https://thunderbolttechnology.net/products>.

Digital Media Slots

- (1) SD UHS-II Flash Media slot (Supports next generation SD (Secure Digital) and is backward compatible to SDHC, SDXC)
- (1) Integrated Smart Card Reader (Compatible with ISO 7816 compliant Smart Cards PC/SC interface support)

SERVICE AND SUPPORT

Limited 3-year or 1-year limited warranty options available, depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Optional* HP Care Pack Services are extended service contracts which go beyond your standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at <http://www.hp.com/go/cpc>.

*Sold separately or as an optional feature. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product. Consult your local HP Customer Support Center for details.

Technical Specifications – System Unit

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)	Nominal Operating Voltage	19.5 V	
	Average Operating Power	DreamColor Without DreamColor	25 W Windows® 10 (64-bit) 16.8 W Windows® 10 (64-bit)
	Max Operating Power	< 200 W	
Temperature	Operating	32° to 95° F (0° to 35° C)	
	Non-operating	-4° to 140° F (-20° to 60° C)	
Relative Humidity	Operating	10% to 90%, non-condensing	
	Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature	
Shock	Operating	40 G, 2 ms, half-sine	
	Non-operating	200 G, 2 ms, half-sine	
Random Vibration	Operating	0.75 grms	
	Non-operating	1.50 grms	
Altitude (unpressurized)	Operating	-50 to 10,000 ft (-15.24 to 3,048 m)	
	Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)	
Industry Standard Certifications	UL	Yes	
	CSA	Yes	
	FCC Compliance	Yes	
	ENERGY STAR®	Select models*	
	EPEAT	Gold **	
	ICES	Planned	
	Australia / NZ A-Tick Compliance	Planned	
	CCC	Planned	
	Japan VCCI Compliance	Planned	
	KC	Planned	
	BSMI	Planned	
CE Marking Compliance	Planned		
MIL STD 810G	Planned***		

* Configurations of the HP ZBook 17 that are ENERGY STAR qualified are identified as HP ZBook 17 G5 ENERGY STAR® on HP websites and on <http://www.energystar.gov>.

** EPEAT® Gold registered where applicable. EPEAT registration varies by country. See <http://www.epeat.net> for registration status by country. See HP's 3rd party option store for solar energy accessory www.hp.com/go/options.

*** MIL STD 810G testing is pending and is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

For accessibility information on HP products, please visit: <http://www.hp.com/accessibility>.

Technical Specifications – Displays

DISPLAYS

17.3" diagonal HD+ AG LED IPS (1600 X 900) (220 nits)	Dimensions (W x H)	398.6*251 (mm)		
	Weight	550g max		
	Diagonal Size	17.3 in (43.9 cm)		
	Surface Treatment	Anti-glare		
	Contrast Ratio	400:1 (typical)		
	Refresh Rate	60 Hz		
	Brightness*	220 nits (typical)		
	Pixel Resolution	Format	1600 x 900	
		Configuration	RGB Stripe	
	Backlight	LED		
	PPI	106		
	Viewing Angle	45/45/35/25 (Left/Right/Down/Up) (typical)		

* For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

17.3" diagonal FHD AG LED IPS with Ambient light sensor (1920 x 1080) (300 nits)	Dimensions (W x H)	398.6*251.0 (mm)		
	Weight	550g max		
	Diagonal Size	17.3 in (43.9 cm)		
	Surface Treatment	Anti-glare		
	Contrast Ratio*	800:1 (typical)		
	Refresh Rate*	60 Hz		
	Brightness*	300 nits (typical)		
	Pixel Resolution	Format	1920 X 1080	
		Configuration	RGB Stripe	
	Backlight	LED		
	PPI	128		
	Viewing Angle	85/85/85/85 (Left/Right/Down/Up) (typical)		

* For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

HP DreamColor Display 17.3" diagonal UHD IPS AG - 10 (8+2) bit color (3840x2160) (400 nits) 100% AdobeRGB	Dimensions (W x H)	398.6*230.95 (mm)		
	Weight	550g max		
	Diagonal Size	17.3 in (43.9 cm)		
	Surface Treatment	Anti-glare		
	Contrast Ratio	1000:1 (typical)		
	Refresh Rate	60 Hz		
	Brightness*	400 nits (typical)		
	Color Gamut	100% AdobeRGB		
	Pixel Resolution	Format	3840 x 2160	
		Configuration	RGB Stripe	
	Backlight	RG phosphors + B-LED		

Technical Specifications – Displays

PPI	254
Viewing Angle	85/85/85/85 (Left/Right/Down/Up) (typical)
* For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.	

17.3" diagonal UHD LED IPS, Touch, with Ambient light sensor (3840x2160) (400 nits)	Dimensions (W x H)	398.6*230.95 (mm)
	Weight	550 g (max)
	Surface Treatment	Anti-glare
	Contrast Ratio	1000:1 (typical)
	Refresh Rate	60 Hz
	Brightness*	400 nits (typical)
	Pixel Resolution	Format 3840 x 2160 (UHD)
		Configuration RGB Stripe
	Backlight	LED
	PPI	254
Viewing Angle	85/85/85/85 (Left/Right/Down/Up) (typical)	
* For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.		

Technical Specifications - Storage and Drives

STORAGE AND DRIVES

Internal Storage

2 TB 5400 rpm SATA Hard Disk Drive	Drive Weight	0.21 lbs (95 g)
	Capacity	2 TB
	Height	0.28 in (7 mm)
	Width	2.75 in (69.85 mm)
	Interface	ATA-8, SATA 3.0
	Transfer Rate	Synchronous (maximum) 600 MB/s
	Seek Time	Single Track 1.5 ms
	(typical reads, including settling)	Average 13 ms
		Maximum 32 ms
	Cache	128 MB
	Rotational Speed	5400 rpm
	Logical Blocks	3,907,029,168
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
Features	ATA Security, S.M.A.R.T., NCQ, Ultra DMA	

500 GB 7200 rpm SATA Hard Disk Drive	Drive Weight	0.21 lbs (95 g)
	Capacity	500 GB
	Height	0.28 in (7 mm)
	Width	2.75 in (69.85mm)
	Interface	ATA-8, SATA 3.0
	Transfer Rate	Synchronous (maximum) 600 MB/s (Drive Capability)
	Seek Time	Single Track 1.5 ms ~ 2 ms
	(typical reads, including settling)	Average 11 ms ~ 13 ms
		Maximum 18 ms ~ 22 ms
	Cache	Up To 32 MB
	Rotational Speed	7200 rpm
	Logical Blocks	976,773,168
	Operating Temperature	32° to 140° F (0° to 60° C) [top cover temp]
Features	ATA Security, S.M.A.R.T., NCQ, Ultra DMA	

Technical Specifications - Storage and Drives

1 TB 7200 rpm SATA Hard Drive Disk Drive	Weight	0.21 lbs (95 g)	
	Capacity	1 TB	
	Height	0.28 in (7 mm)	
	Width	2.75 in (69.85mm)	
	Interface	ATA-8, SATA 3.0	
	Transfer Rate	Synchronous (maximum) 600 MB/s	
	Seek Time (typical reads, including settling)	Single Track	1.5 ms
		Average	13 ms
		Maximum	32 ms
	Cache	128 MB	
	Rotational Speed	7200 rpm	
	Logical Blocks	1,953,525,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [top cover temp]	
	Features	ATA Security, S.M.A.R.T., NCQ, Ultra DMA	
	500 GB Hybrid, 8 GB cache	Drive Weight	0.20 lbs (92 g) ~ 0.21 lbs (95 g)
Capacity		500 GB	
Height		0.28 in (7 mm)	
Width		2.75 in (69.85 mm)	
Interface		ATA-8, SATA 3.0	
Transfer Rate		Synchronous (maximum) 600 MB/s	
Seek Time (typical reads, including settling)		Single Track	2 ms
		Average	12 ms
		Maximum	22 ms
Cache		Up to 64MB	
Rotational Speed		5400 rpm	
Logical Blocks		976,773,168	
Operating Temperature		32° to 140° F (0° to 60° C) [case temp]	
Features		ATA Security, S.M.A.R.T., NCQ, Ultra DMA	
1 TB Hybrid, 8 GB cache		Drive Weight	90g
	Capacity	1 TB	
	Height	0.28 in (7 mm)	
	Width	2.75 in (69.85 mm)	
	Interface	ATA-8, SATA 3.0	
	Transfer Rate	Synchronous (maximum) 600 MB/s	
	Seek Time (typical reads, including settling)	Single Track	1.5 ms
		Average	13 ms
		Maximum	32 ms
	Cache	Up to 128MB	
	Rotational Speed	5400 rpm	
	Logical Blocks	1,953,525,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]	
	Features	ATA Security, S.M.A.R.T., NCQ, Ultra DMA	

Technical Specifications - Storage and Drives

2 TB Hybrid, 8 GB cache

Drive Weight	90g
Capacity	2 TB
Height	0.28 in (7 mm)
Width	2.75 in (69.85 mm)
Interface	ATA-8, SATA 3.0
Transfer Rate	Synchronous (maximum) 600 MB/s
Seek Time (typical reads, including settling)	Single Track 1.5 ms
	Average 13 ms
	Maximum 32 ms
Cache	Up to 128MB
Rotational Speed	5400 rpm
Logical Blocks	3,907,029,168
Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
Features	ATA Security, S.M.A.R.T., NCQ, Ultra DMA

500 GB 7200 rpm SATA SED FIPS-140-2 compliant Hard Disk Drive

Drive Weight	0.21 lbs (95g)
Capacity	500 GB
Height	0.28 in (7 mm)
Width	2.75 in (69.85 mm)
Interface	ATA-8, SATA 3.0
Transfer Rate	Synchronous (maximum) 600 MB/s (Drive Capability)
Seek Time (typical reads, including settling)	Single Track 1.5 ms
	Average 12 ms
	Maximum 21 ms
Cache	32 GB
Rotational Speed	7200 rpm
Logical Blocks	976,773,168
Operating Temperature	32° to 140° F (0° to 60° C) [top cover temp]
Features	ATA Security; TCG Opal 2.x, FIPS, S.M.A.R.T., NCQ, Ultra DMA
* FIPS-certified, hardware-based AES-256 encryption image.	

500 GB 7200 rpm SATA SED Hard Disk Drive

Drive Weight	0.21 lbs (95g)
Capacity	500 GB
Height	0.28 in (7 mm)
Width	2.75 in (69.85 mm)
Interface	ATA-8, SATA 3.0
Transfer Rate	Synchronous (maximum) 600 MB/s (Drive Capability)
Seek Time (typical reads, including settling)	Single Track 1.5 ms
	Average 12 ms
	Maximum 21 ms

Technical Specifications - Storage and Drives

Cache	32 MB
Rotational Speed	7200 rpm
Logical Blocks	976,773,168
Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
Features	ATA Security, TCG Opal 2.x, S.M.A.R.T., NCQ, Ultra DMA

256 GB SATA TLC Solid State Drive (2.5")

Drive Weight	0.17 lb (78 g)
Capacity	256 GB
Height	0.28 in (7 mm)
Width	2.75 in (69.85 mm)
Interface	ATA-8, SATA 3.0
NAND	TLC
Form Factor (I/O)	2.5 inch
Performance	Maximum Sequential Read Maximum Sequential Write
	530 MB/s ~ 560 MB/s 500 MB/s ~ 525 MB/s
Logical Blocks	500,118,192
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	ATA Security; DIPM; TRIM; DEVSLP

1 TB SATA TLC Solid State Drive (2.5")

Drive Weight	0.17 lb (78 g)
Capacity	1 TB
Height	0.28 in (7 mm)
Width	2.75 in (69.85 mm)
Interface	ATA-8, SATA 3.0
NAND	TLC
Form Factor (I/O)	2.5 inch
Performance	Maximum Sequential Read Maximum Sequential Write
	530 MB/s ~ 560 MB/s 500 MB/s ~ 530 MB/s
Logical Blocks	2,000,409,264
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	ATA Security; DIPM; TRIM; DEVSLP

256 GB M.2SED TLC Solid State Drive

Drive Weight	0.02 lb (<10 g)
Capacity	256 GB
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Interface	ATA-8, SATA 3.0
NAND	TLC
Form Factor (I/O)	M.2 2280
Performance	Maximum Sequential Read Maximum Sequential Write
	530 MB/s ~ 560 MB/s 500 MB/s ~ 530 MB/s

Technical Specifications - Storage and Drives

	Logical Blocks	500,118,192		
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
	Features	ATA Security; TCG Opal 2.0, DIPM; TRIM; DEVSLP		
512 GB M.2 FIPS-140-2 TLC Solid State Drive	Drive Weight	0.02 lb (<10 g)		
	Capacity	512 GB		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Generation	Micron 1100		
	Interface	ACS-3, SATA 3.2		
	NAND Type	TLC		
	Form-Factor (I/O)	M.2 2280		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
			Up to 530MB/s	Up to 400MB/s
	Logical Blocks	1,000,215,216		
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
	Features	ATA Security; TCG Opal 2.0; FIPS; DIPM; TRIM; DEVSLP		
360GB M.2 TLC Solid State Drive	Drive Weight	0.02 lb. (10 g)		
	Capacity	360 GB		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Generation	Intel® Pleasant Star		
	Interface	PCIe NVMe Gen3X4		
	NAND Type	TLC		
	Form-Factor (I/O)	M.2 2280		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
			Up to 1700MB/s(Compressible Performance)	Up to 600 MB/s(Compressible Performance)
	Logical Blocks	703,282,608		
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
	Features	ATA Security (Option); TRIM; L1.2		
256 GB M.2 NVMe TLC Solid State Drive	Drive Weight	0.02 lb (<10 g)		
	Capacity	256 GB		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Generation	Samsung PM961/ Toshiba XG5		
	NAND Type	TLC		
	Form-Factor (I/O)	M.2 2280		
	Interface	PCIe NVMe Gen3X4		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
			2580 MB/s ~ 2600 MB/s	1000 MB/s ~ 1100 MB/s

Technical Specifications - Storage and Drives

Logical Blocks	500,118,192
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	ATA Security (Option),TRIM; L1.2

256 GB M.2 NVMe TLC SED Solid State Drive

Drive Weight	0.02 lb (<10 g)
Capacity	256 GB
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Generation	Samsung PM961 SED Opal2/ Toshiba XG5 SED Opal2
NAND Type	TLC
Form-Factor (I/O)	M.2 2280
Interface	PCIe NVMe Gen3X4
Performance	Maximum Sequential Read Maximum Sequential Write
	2580 MB/s ~ 2600 MB/s Up to 1000 MB/s

Logical Blocks	500,118,192
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	ATA Security (Option); TCG Opal 2.0; TRIM; L1.2

512 GB M.2 NVMe TLC Solid State Drive

Drive Weight	0.02 lb (<10 g)
Capacity	512 GB
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Generation	Samsung PM981 / Toshiba XG5
NAND Type	TLC
Form-Factor (I/O)	M.2 2280
Interface	PCIe NVMe Gen3X4
Performance	Maximum Sequential Read Maximum Sequential Write
	2800 MB/s ~ 2900 MB/s 1000 MB/s ~ 1800 MB/s

Logical Blocks	1,000,215,215
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	ATA Security,TRIM; L1.2

512 GB M.2 NVMe TLC Solid State Drive

Drive Weight	0.02 lb (<10 g)
Capacity	512 GB
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Generation	Samsung PM981 SED Opal2/ Toshiba XG5 SED Opal2
NAND Type	TLC
Form-Factor (I/O)	M.2 2280
Interface	PCIe NVMe Gen3X4
Performance	Maximum Sequential Read Maximum Sequential Write
	2800 MB/s ~ 2900 MB/s 1000 MB/s ~ 1800 MB/s

Logical Blocks	1,000,215,215
-----------------------	---------------

Technical Specifications - Storage and Drives

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]
Features ATA Security (Option); TCG Opal 2.0 ; TRIM; L1.2

1 TB, M.2 NVMe TLC Solid State Drive

Drive Weight 0.02 lb (<10 g)
Capacity 1 TB
Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Generation Samsung PM981 / Toshiba XG5
NAND Type TLC
Form-Factor (I/O) M.2 2280

Interface PCIe NVMe Gen3X4
Performance **Maximum Sequential Read** **Maximum Sequential Write**
 2900 MB/s ~ 3000 MB/s Up to 2000MB/s

Logical Blocks 2,000,409,264
Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]
Features ATA Security, TRIM; L1.2

2 TB, M.2 NVMe TLC Solid State Drive

Drive Weight 0.02 lb (<10 g)
Capacity 2 TB
Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Generation Toshiba XG5P
NAND Type TLC
Form-Factor (I/O) M.2 2280

Interface PCIe NVMe Gen3X4
Performance **Maximum Sequential Read** **Maximum Sequential Write**
 Up to 2900MB/s Up to 2100 MB/s

Logical Blocks 3,907,029,168
Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]
Features ATA Security, TRIM; L1.2

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows® 10) disk is reserved for system recovery software.

Technical Specifications – Networking and Communications

NETWORKING/COMMUNICATIONS

Intel® I219-LM Gigabit Network Connection	Ethernet Features	<p>10 Mbit/s operation (10BASE-T; IEEE 802.3; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 802.3. Clauses 40) IEEE 802.3u Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE(Energy Efficient Ethernet) IEEE 802.1as/1588 conformance Jumbo Frame 9K Auto MDI/MDIX Crossover cable detection</p>
	Power Management	ACPI compliant - multiple power modes
	Performance Features	<p>Energy Detect Low Power Mode(Green Ethernet) TCP/IP/UDP Checksum Offload (configurable) Protocol Offload(ARP & NS) Large send offload and Giant send offload Receiving Side Scaling MACSec Offload (802.3ae) Intel® vPro™ iSCSI Boot RSS (Receive Side Scaling) Ultra Low Power</p>
	Manageability	<p>Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status</p>
	Interface	<p>PCI Express 1.1 x1 to fully support ASPM L0s/L1 and CLKREQ. NOTE: Intel® I219-LM Gigabit interface is not PCIe compliant. It operates at half of PCIe specification V1.1 (2.5GT/S) speed.</p>
	NIC Device Driver Name	Intel® Ethernet Network Connection I219-LM

Technical Specifications – Networking and Communications

Intel®XMM™ 7360 LTE-Advanced	Technology/Operating Bands	FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 1400 (Band 11), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1400 (Band 21), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 2100 (Band 66). TDD LTE: 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41). HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz
	Wireless Protocol Standards	3GPP Release 11 LTE Specification CAT.9, DL 60MHz BW throughput up to 450Mbps; UL 20MHz throughput up to 50Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
	GPS	Standalone, A-GPS (MS-A, MS-B and XTRA)
	GPS Bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz
	Maximum Data Rates	LTE: 450 Mbps (Download), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
	Maximum Output Power	LTE: 23 dBm HSPA+: 23.5 dBm
	Maximum Power Consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
	Form Factor	M.2, 3042-S3 Key B
	Weight	5.8g
	Dimensions (Length x Width x Thickness)	1.65 x 1.18 x 0.09 in (42 x 30 x 2.3 mm)

* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

Technical Specifications – Networking and Communications

HP It4132 LTE/HSPA+ w/GPS	Technology/Operating bands	LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 800 MHz (Band 20, DD800) MHz HSPA+: 2100 (Band 1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8) MHz
	Wireless protocol standards	3GPP Release 8 LTE Specification WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification E-GPRS: Class B, Multi-slot class 33, coding schemes CS1 - CS4 and MSC1 - MSC9
	GPS	Standalone, A-GPS
	GPS bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz
	Maximum data rates	LTE: 100 Mbps (Download), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)
	Maximum output power	LTE: 23 dBm HSPA+: 23.5 dBm E-GPRS 1900/1800: 26.5 dBm E-GPRS 900/850: 27.5 dBm GPRS 1900/1800: 29.5 dBm GPRS 900/850: 32.5 dBm
	Maximum power consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average) E-GPRS: 2,800 mA (peak); 700 mA (average)
	Form Factor	M.2, 3042-S3 Key B
	Weight	6 g
	Dimensions (Length x Width x Thickness)	1.65 x 1.18 x 0.09 in (42 x 30 x 2.3 mm)

* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

Technical Specifications – Networking and Communications

<p>Intel® Dual Band Wireless-N 9560AC 802.11 a/b/g/n (2x2) WiFi + Bluetooth 5.0 Combo Adaptor*</p>	<p>Wireless LAN Standards</p>	<p>IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac</p>
	<p>Interoperability</p>	<p>Wi-Fi certified</p>
	<p>Frequency Band</p>	<p>802.11b/g/n 802.11a/n</p>
		<p>2.402 - 2.482 GHz Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels. 4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz Note: No support for this band in Indonesia</p>
	<p>Data Rates</p>	<p>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15 (20MHz and 40MHz) 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)</p>
	<p>Modulation</p>	<p>Direct Sequence Spread Spectrum CCK, BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM</p>
	<p>Security¹</p>	<ul style="list-style-type: none"> • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • IEEE 802.11i • Cisco Certified Extensions, all versions through CCX4 and CCX Lite • WAPI
	<p>Network Architecture Models</p>	<p>Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)</p>
	<p>Roaming</p>	<p>IEEE 802.11 compliant roaming between band Access Points</p>
	<p>Output Power²</p>	<p>802.11b : +16dBm minimum 802.11g : +14dBm minimum 802.11a : +14dBm minimum 802.11n HT20(2.4GHz) : +14dBm minimum 802.11n HT40(2.4GHz) : +12dBm minimum 802.11n HT20(5GHz) : +14dBm minimum 802.11n HT40(5GHz) : +12dBm minimum</p>
	<p>Power Consumption</p>	<p>Transmit: 2.0 Watts Receive: 1.6 Watts Idle mode: 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connect Standby: 10 mW (WLAN+BT) Radio disabled: 5 mW</p>

Technical Specifications – Networking and Communications

Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode	
Receiver Sensitivity³	802.11b, 1Mbps : -94dBm maximum 802.11b, 11Mbps : -86dBm maximum 802.11g, 6Mbps : -88dBm maximum 802.11g, 54Mbps : -74dBm maximum 802.11a, 6Mbps : -88dBm maximum 802.11a, 54Mbps : -74dBm maximum 802.11n, MCS07 : -69dBm maximum 802.11n, MCS15 : -66dBm maximum 802.11ac, 1SS, MCS-0 : -86dBm maximum 802.11ac, 1SS, MCS-9 : -61dBm maximum 802.11ac, 2SS, MCS-0 : -83dBm maximum 802.11ac, 2SS, MCS-9 : -58dBm maximum	
Antenna Type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications	
Form Factor	PCI-Express M.2 MiniCard	
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm Or Type 1630 : 2.3 x 16.0 x 30.0 mm	
Weight	Type 2230 : 2.8g Or Type 1630 : 2g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating	Temperature
	Non-operating	
Humidity	Operating	Humidity
	Non-operating	
Altitude	Operating	Altitude
	Non-operating	
LED Activity	LED Amber - Radio OFF; LED White - Radio ON	

1. Check latest software/driver release for updates on supported security features.
 2. Maximum output power may vary by country according to local regulations.
 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
- * Wireless access point and internet service required. Availability of public wireless access points limited.

HP Integrated Module with Bluetooth 4.2 Wireless Technology

Bluetooth Specification	4.2 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Technical Specifications – Networking and Communications

Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.												
Receiver Sensitivity	<table border="1"> <thead> <tr> <th>Modulation</th> <th>0.01% BER</th> <th>0.001% BER</th> </tr> </thead> <tbody> <tr> <td>GFSK</td> <td>-80 dBm</td> <td>-70 dBm</td> </tr> <tr> <td>$\pi/4$-DQPSK</td> <td>-80 dBm</td> <td>-70 dBm</td> </tr> <tr> <td>8DPSK</td> <td>-80 dBm</td> <td>-70 dBm</td> </tr> </tbody> </table>	Modulation	0.01% BER	0.001% BER	GFSK	-80 dBm	-70 dBm	$\pi/4$ -DQPSK	-80 dBm	-70 dBm	8DPSK	-80 dBm	-70 dBm
Modulation	0.01% BER	0.001% BER											
GFSK	-80 dBm	-70 dBm											
$\pi/4$ -DQPSK	-80 dBm	-70 dBm											
8DPSK	-80 dBm	-70 dBm											
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW												
Range	Legacy Up to 33 ft (10 m) BLE Up to 99 ft (30 m)												
Electrical Interface	USB 2.0 compliant												
Bluetooth Software Supported	Microsoft Windows® Bluetooth Software												
Link Topology	Point to Point, Multipoint Pico Nets up to 7 slaves												
Security	Full support of Bluetooth Security Provisions												
Power Management	Microsoft Windows® ACPI, and USB Bus Support Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff												
Certifications	All necessary regulatory approvals for supported countries, including: FCC (47 CFR) Part 15C, Section 15.247 & 15.249 ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark												
Bluetooth Profiles Supported	Serial Port Profile (SPP) Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) Generic Object Exchange Profile (GOEP) Object Push Profile (OPP) Hard Copy Cable Replacement (HCRP) Personal Area Networking Profile (PAN) Human Interface Device Profile (HID) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) Audio Video Remote Control Profile (AVRCP)												

Near Field Communications (NFC) Controller (optional)

Controller Supports	NFC Mirage WNC XRAV-1 (NXP NPC300 I2C 10mmx17mm) <ul style="list-style-type: none"> • Windows 8, Proximity Events • Windows 7, PC/SC • NFC Forum Compliant • Near Field Communications Controller
----------------------------	---

Dimensions (L x W x H)	Module 25 mm by 10 mm by 2.0 mm
Chipset	NPC100
System interface	I2C
NFC RF standards	standards ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092 ECMA-340 NFCIP-1 Target and Initiator ECMA-320 NFCIP-2

Technical Specifications – Networking and Communications

NFC Forum Support Tag Reader	Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2 (PCD-VCD) Mode(1) ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire FeliCa Jewel and Topaz cards	
Card Emulation	(PICCVICC)	
Mode	ISO/IEC 14443 A ISO/IEC 14443 B and B' MIFARE FeliCa	
Frequency	13.56 MHz	
NFC Modes Supported	Reader/Writer, Peer-to-Peer	
Raw RF Data Rates	106, 212, 424, 848 kbps	
Operating temperature	0°C to 70°C	
Storage temperature	-20°C to 125°C	
Humidity	10-90% operating 5-95% non-operating	
Supply Operating voltage	2.97 to 5.5 Volts	
I/O Voltage	1.8V or 3.3V	
Power Consumption	Booster enable, VCC_BOOST = 5V) Mode Power Consumption,	VBAT= 3.3V, Typical ² Polling 7.3 mA Detected Test Tag Type 1 Total 283.8 mA Net Module 236.8 mA Detected Test Tag Type 2 Total 288.8 mA Net Module 241.8 mA Detected Test Tag Type 3 Total 287.7 mA Net Module 240.7 mA Detected Test Tag Type 4 Total 282.3 mA Net Module 235.3 mA
Antenna connector	0.5mm pitch, 7 connector FPC. Antenna matching is external to module.	
Notes	<ol style="list-style-type: none"> 1. With application or UICC support 2. Actual Power Consumption is dependent on NFC antenna and matching circuit and on the particular polling sequence and period configured. 	

Technical Specifications – Audio and Multimedia

AUDIO/MULTIMEDIA – BANG & OLUFSEN

Hardware	Implementation	Synaptics CX8400 with two NXP TFA9891 discrete smart amplifiers
	Function Key	Volume up, volume down, and mute
	Volume Controls	
	Full Duplex	Yes
	Microphone In	Stereo
	Headphone/Line Out	Stereo
	Integrated Microphone	Yes, three digital microphone array when equipped with optional webcam
Audio Output Quality	Frequency Response	20 Hz - 20 kHz
	Signal to Noise Ratio	106dB (DAC), 102dB (ADC)
	Total Harmonic Distortion	91dB THD+n on LineOut/HP (0.003%)
	Noise Floor	-110 dB
	Play Sampling Rate(s)	Up to 192kHz
	Record Sampling Rate(s)	Up to 96kHz
	DAC	16, 20 or 24-bit
	ADC	16, 20 or 24-bit
Internal Stereo Speaker	Power Rating	1 Watt/per speaker
	Impedance	8 ohms/per speaker

Technical Specifications – Environmental

POWER

HP 200W Slim Smart AC Adapter	Dimensions	(165 x 79 x 25.4 mm)	
	Weight	530 g	
	Input	Input	100 to 240 VAC
		Input Efficiency	88% min at 115 VAC
		Input frequency range	47 to 63 Hz
	Output	Input AC current	2.9 A at 90 VAC, 1.45 A at 90 VAC
		Output power	200W
		DC output	19.5V
		Hold-up time	5 msec at 115 VAC input
		Output current protection	16A max auto-recovery
	Connector	Over voltage protection	29V max automatic shutdown
		3 pin/grounded, 4.5mm barrel type	
	Environmental Design	Operating temperature	32° to 95° F (0° to 35° C)
		Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
		Altitude	0 to 16404 ft (0 to 5,000 m)
Storage Humidity		10% to 95%	
EMI and Safety Certifications	CE Mark- full compliance with LVD and EMC directives; Worldwide safety standards- IEC950, EN60950, UL1950, Class 1, SELV; Agency approvals- C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCIB, NOM-1 NYCE; MTBF- over 200,000 hours at 25°C ambient condition.		

HP Long Life 6-cell Prismatic Battery (96 WHr)	Dimensions (H x W x L)	9.9x3.26x0.726 in (25.16x8.29x1.844cm)		
	Weight (max)	1.12lb (420g)		
	Cells/Type	6-cell; Polymer		
	Energy	Voltage	11.4V	
		Amp-hour capacity	8.42Ah	
		Watt-hour capacity	96Wh	
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)	
		Operating (Discharging)	14° to 140° F (-10° to 60° C)	
		Non-operating	-4° to 140° F (-20° to 60° C)	
	Battery Re-Charge Time	System in OFF or Standby Mode	3 hours	
		System ON	3 to 5 hours	
	Fuel Gauge LED	No		
	Warranty*	3 year		
Charge Rate	0.7C; HP Fast Charge 90% charge in 90 minutes			
Compatible with optional Travel Battery	N/A			

* 3-year platform warranty is required for a 3-year Long Life Battery warranty.

Technical Specifications – Environmental

ENVIRONMENTAL DATA

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT® Gold registered in the United States. See <http://www.epeat.net> for registration status in your country.

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a “Typically Configured Notebook”.

Energy Consumption (in accordance with US ENERGY STAR® test method)

	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Sort idle)	14.53 W	15.11 W	14.68 W
Normal Operation (Long idle)	6.94 W	7.37 W	6.84 W
Sleep	0.83 W	0.88 W	0.83 W
Off	0.44 W	0.47 W	0.44 W

Note:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*

	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	50 BTU/hr	52 BTU/hr	50 BTU/hr
Normal Operation (Long idle)	24 BTU/hr	25 BTU/hr	23 BTU/hr
Sleep	3 BTU/hr	3 BTU/hr	3 BTU/hr
Off	1 BTU/hr	2 BTU/hr	1 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)
Typically Configured – Idle	3.3	29
Fixed Disk – Random writes	3.4	29
Optical Drive – Sequential reads		

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 4 USB ports
- 2 Thunderbolt™ 3 ports
- 2 2.5” Storage Bay Drives
- 2 M.2 SATA SED Solid State Drives
- 1 Smart Card Reader

Technical Specifications – Environmental

- 1 SD Card reader
- 4 SODIMM memory slots
- 1 HDMI 1.4 port

Spare parts are available throughout the warranty period and or for up to “5” years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:
 Mercury greater than 1ppm by weight
 Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Battery size: 6-cell high capacity Lithium-Ion battery (optional 8 cell available)

Battery type:

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 0.0% post-consumer recycled plastic (by wt.)

This product is 95.2% recycle-able when properly disposed of at end of life.

Packaging Materials

External:	PAPER/Corrugated	445 g
Internal:	PLASTIC/Polyethylene low density - LDPE	19 g
	PLASTIC/Polyethylene Expanded - EPE	90 g
	PLASTIC/Polypropylene - PP	7 g

The plastic packaging material contains at least 81.5% recycled content.

The corrugated paper packaging materials contains at least 80.0% recycled content.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

<http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf>):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants – may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances

Technical Specifications – Environmental

- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) – except for wires and cables, has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <http://www.hp.com/go/reuse-recycle> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <http://www.hp.com/go/recyclers>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP, Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

<http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html>

Eco-label certifications

<http://www8.hp.com/us/en/hp-information/environment/ecolabels.html>

ISO 14001 certificates:

<http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842>

and

<http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf>

COUNTRY OF ORIGIN

China

Options and Accessories (sold separately and availability may vary by country)

Type	Description	Part #
Memory	HP 4GB DDR4-2666 SODIMM	TBD
	HP 8GB DDR4-2666 SODIMM	TBD
	HP 16GB DDR4-2666 SODIMM	TBD
	HP 8GB DDR4-2666 ECC SODIMM	TBD
	HP 16GB DDR4-2666 ECC SODIMM	TBD
Cases	HP 17" Business Top Load Case	2UW02AA
Docking	HP ZBook Dock with Thunderbolt 3 (150W)	P5Q58AA
	HP ZBook Dock with Thunderbolt 3 (200W)	P5Q61AA
	HP USB-C Travel Dock	TOK29AA
	HP USB Travel Dock	TOK30AA
	HP Elite USB-C Dock	Z9R42AA
	HP Elite USB-C Dock G3	2DW60AA
	HP USB-C Dock G4	3FF69AA#xxx
	HP Thunderbolt Dock 230W G2	2UK38AA
	HP USB-C Universal Dock	1MK33AA
	HP USB-C Mini Dock	1PM64AA
	HP Elite USB-C Docking Station	X7W54AA
	HP ZBook Thunderbolt 3 1m cable	Z4P20AA
	HP Thunderbolt 230W 1m cable	3AQ24AA
	HP Thunderbolt 1m combo cable	3AQ25AA
HP Thunderbolt Dock Audio	3AQ21AA	
Input/Output - Mice	HP Slim USB Keyboard and Mouse	T6T83AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Wireless (Link-5) Keyboard	T6U20AA
	HP USB Collaboration Keyboard	Z9N38AA#xxx
	HP Wireless Collaboration Keyboard	Z9N39AA#xxx
	HP 3-Button Laser Mouse	H4B81AA#xxx
	HP USB Premium Mouse	1JR32AA
	HP Wireless Premium Mouse	1JR31AA
	HP USB Essential Keyboard and Mouse	H6L29AA
	HP Ultra Mobile Wireless Mouse	H6F25AA#xxx
	HP X4000 Bluetooth Mouse	H3T50AA#xxx
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP Bluetooth mouse	F3J92AA#xxx
	HP USB Smart Card Reader	F6V67AA
Power Adapters	HP 200W SLIM Smart AC Adapter	W2F75AA
Battery	96Whr Battery	TBD

Options and Accessories (sold separately and availability may vary by country)

Adapters	HP USB-C to USB-A Hub	Z6A00AA
	HP USB-C to VGA Adapter	N9K76AA
	HP USB-C to DisplayPort™ Adapter	N9K78AA
	HDMI to VGA Adapter	H4F02AA
	HDMI to DVI adapter	F5A28AA
	USB-C to DP	N9K78AA
	HP dual output wireless adapter	C5U89AA
	USB-C to RJ45	V7W66AA
	USB 3.0 to RJ45	N7P47AA
USB-C to HDMI 1.4	N9K77AA	
Storage - External Storage	HP 1TB 7200RPM 9.5mm SATA HDD	L3M56AA
	HP 180GB M2 SATA-3 SSD (2280)	J2V73AA
	HP 256GB M2 SATA-3 SSD (2280)	J2V74AA
	HP 256GB M2 PCIe SSD (2280)	TBD
	HP 512GB M2 PCIe SSD (2280)	TBD
	HP USB External DVDRW Drive	F2B56AA
Security	HP Essential Combination Lock	TOY16AA
	HP Combination Lock	TOY15AA
	HP Keyed Cable lock	TOY14AA
	HP Keyed Cable Lock 10mm	T1A62AA
	HP Dual Head Keyed Cable Lock	T1A64AA
	HP 3 year Next business day onsite Hardware Support w/Accidental Damage Protection-G2 for Notebooks	UF631E
Collaboration	HP UC Wireless Mono Headset	W3K08AA
	HP UC Wireless Duo Headset	W3K09AA
	HP Conferencing Keyboard	K8P74AA#xxx
	HP UC Speaker Phone	K7V16AA
	HP UC Wired Headset	K7V17AA
	HP Elite Presenter Mouse	2CE30AA#xxx
	HP Stereo 3.5mm Headset	T1A66AA
	HP Stereo USB Headset	T1A67AA

Summary of Changes

Date of change:	Version History:		Description of change:
	From v1 to v2		

Copyright © 2018 HP Development Company, L.P.

The information contained herein is subject to change without notice. The only warranties for HP products are set forth in the express limited warranty statements accompanying such products. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein.

Intel, Core, vPro, Xeon, Celeron and Thunderbolt are registered trademarks or trademarks of Intel Corporation in the U.S. and/or other countries. Bluetooth is a registered trademark of its proprietor, used by HP Inc. under license. Adobe is a trademark of Adobe Systems Incorporated. Qualcomm and Snapdragon are trademarks of Qualcomm, Inc. ENERGY STAR is a registered trademark mark of the U.S. Environmental Protection Agency. Microsoft and Windows are registered trademarks of Microsoft Corporation in the United States and/or other countries. AMD, Enduro and FirePro are trademarks of Advanced Micro Devices, Inc. NVIDIA, the NVIDIA logo, Optimus and Quadro are trademarks and/or registered trademarks of NVIDIA Corporation in the U.S. and other countries. SD, SDHC, and SDXC are trademarks or registered trademarks of SD-3C in the United States, other countries or both. USB Type-C and USB-C are trademarks of USB Implementers Forum. DisplayPort™ and the DisplayPort™ logo are trademarks owned by the Video Electronics Standards Association (VESA®) in the United States and other countries.